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DATA SHEET

AWB7231: 2.01 to 2.025 GHz Small-Cell Power Amplifier Module

Applications

- LTE, WCDMA and HSDPA air interfaces
- FDD and TDD systems
- Picocell, femtocell, home nodes
- · Customer premises equipment
- · Data cards and terminals

Features

- InGaP HBT technology
- -47 dBc ACPR @ ±10 MHz, +27 dBm
- 29.5 dB gain
- High efficiency
- Low transistor junction temperature
- Matched for a 50 Ω system
- Low profile miniature surface-mount package; RoHS compliant
- Multi-carrier capability
- Surface-mount (14-pin, $7 \times 7 \times 1.3$ mm) package (MSL4, 260 °C per JEDEC J-STD-020)





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Description

The AWB7231 is a fully matched, Multi-Chip-Module (MCM) designed for picocell, femtocell, and customer premises equipment (CPE) applications. Its high linearity and efficiency meet the extremely demanding needs of small-cell infrastructure architectures. Designed for LTE,WCDMA, and HSDPA air interfaces operating in the 2.01 to 2.025 GHz band, the AWB7231 delivers up to +27 dBm of LTE (E-TM1.1) power with an ACPR of -47 dBc. The device operates from a convenient +4.5 V supply and provides 29 dB of gain.

The device is manufactured using an advanced InGaP HBT MMIC technology offering state-of-the-art reliability, temperature stability, and ruggedness. The self-contained 7 x 7 x 1.3 mm surface-mount package incorporates RF matching networks optimized for output power, efficiency, and linearity in a 50 Ω system.

A block diagram of the AWB7231 is shown in Figure 1. The device package and pinout are shown in Figure 2. Signal pin assignments and functional pin descriptions are described in Table 1.

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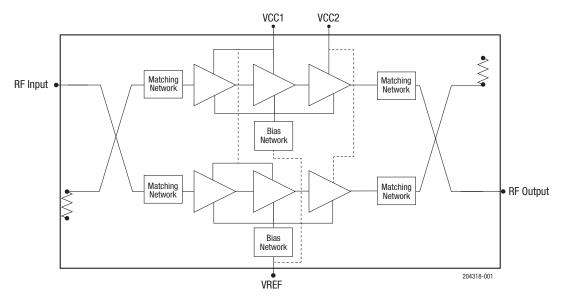


Figure 1. AWB7231 Block Diagram

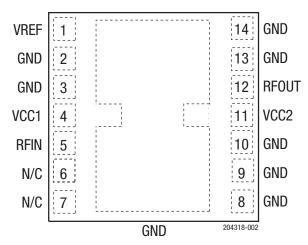


Figure 2. AWB7231 Pinout (Top View)

Table 1. AWB7124 Signal Pin Descriptions

Pin	Name	Description	Pin	Name	Description
1	VREF	Reference voltage	8	GND	Ground
2	GND Ground 9 GND		GND	Ground	
3	GND	Ground	10	GND	Ground
4	VCC1	Supply voltage	11	VCC2	Supply voltage
5	RFIN	RF input	12	RFOUT	RF output
6	N/C	No connection	13	GND	Ground
7	N/C	No connection	14	GND	Ground

Electrical and Mechanical Specifications

The absolute maximum ratings of the AWB7231 are provided in Table 2. Recommended operating conditions are specified in Table 3, and electrical specifications are provided in Table 4.

Table 2. AWB7231 Absolute Maximum Ratings¹

Parameter	Minimum	Maximum	Units
Supply voltage (VCC)		+5	V
Reference voltage (VREF)		+3.5	V
RF output power (POUT)		+30	dBm, modulated
RF input power (PIN)		+10	dBm, CW
Electrostatic discharge: Human Body Model, Class 1C ² Charged Device Model, Class 4 ³		2000 >1000	V V
Junction temperature (TJ)	-	+150	°C
Storage temperature (TSTG)	-40	+150	°C

¹ Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

ESD HANDLING: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device.

This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection.

Industry-standard ESD handling precautions should be used at all times.

Table 3. AWB7231 Recommended Operating Conditions¹

Parameter	Symbol	Min	Тур	Max	Units
Operating frequency	f	2010		2025	MHz
Supply voltage	Vcc	+3.6	+4.5	+4.65	V
Reference voltage:					
PA on PA off	VREF	+2.80 0	+2.85	+2.90 +0.5	V V
RF output power ²	Роит		+27		dBm
Case temperature ³	Tc	-40		+85	°C

¹ The device may be operated safely over these conditions; however, parametric performance is guaranteed only over the conditions defined in the electrical specifications.

² JEDEC JS-001-2010.

³ JEDEC JESD22-C101D.

 $^{{\}bf 2}$ Typ RF output power is used during production test.

 $^{^{3}}$ Case temperature references the board temperature at the ground paddle on the backside of the package.

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Table 4. AWB7231 Electrical Specifications¹

(Tc = +25 °C, Vcc = +4.5 V, VREF = +2.85 V, 50 Ω system)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Gain ²	G		27	29.5	33	dB
ACPR: 1,2,3						
@ 10 MHz @ 20 MHz				–47 –57	–45 –54	dBc dBc
Power-added efficiency ^{1,2,3}			12	14		%
Thermal resistance ⁴	RJC	Junction to case		12.3		°C/W
Supply current ^{1,2,3}	VCC	Total through VCC pins		740	925	mA
Quiescent current	lcq			250	315	mA
Reference current		Through VREF pin	10	14	19	mA
Leakage current		VCC = +4.65 V, VREF = 0 V		3	10	μΑ
Harmonics:						
2fo, 4fo 3fo				-65 -55	-55 -45	dBc dBc
Input return loss ¹			15	18		dB
Output return loss			15	18		dB
RF switching time: ⁵		VCC = +4.5 V, VREF switched between 0 V and				
Rise time (PA off to on) Fall time (PA on to off)		+2.85 V			12 4	μs μs
Spurious output level (all spurious outputs)		$Pout \le +27$ dBm, in-band load VSWR $< 5:1$, Out-of-band load VSWR $< 10:1$, applies over all voltage and temperature operating ranges			-60	dBc
Load mismatch stress with no permanent degradation or failure		VCC = +4.5 V, POUT = +27 dBm Applies over full operating temperature range	8:1			VSWR

Measured at 2017.5 MHz.

 $P_{0UT} = +27 \text{ dBm}.$

³ E-TM1.1 LTE 10 MHz BW.

 $^{^{4}\,\,}$ Use only Vcc2 (pin 11) current when calculating device junction temperature.

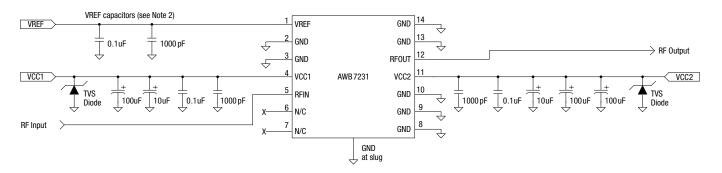
Rise Time defined from time at which VREF is switched from 0 V to +2.85 V, to time at which the RF output power achieves 90% of the average steady-state "on" level; Fall Time defined from time at which VREF is switched from +2.85 V to 0 V, to time at which the RF output power decreases to 10% of the average steady-state "on" level.

Evaluation Board Description

The AWB7231 Evaluation Board is used to test the performance of the AWB7231 device. A schematic of a typical application circuit is shown in Figure 3.

Shutdown Mode

The power amplifier can be placed in shutdown mode by applying logic low levels (see Operating Ranges table) to the V_{REF} voltage.



Notes:

- Applications that have large supply voltage transients may benefit from the use of TVS diodes. For such applications, recommended TVS diodes are SM05T1G or SMJ5.0A.
- To achieve the RF Switching Time specifications listed in Table 4, the maximum recommended capacitance on the VREF line is 0.01 µF.
 The noise on the VREF line should be kept as low as possible to minimize required capacitance.

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Figure 3. AWB7231 Evaluation Board Schematic

Package Dimensions

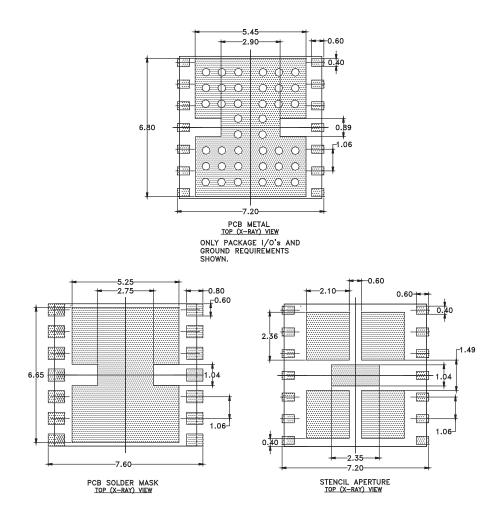
The PCB layout footprint drawing for the AWB7231 is shown in Figure 4. Typical part markings are shown in Figure 5. The package dimensions for the AWB7231 are shown in Figure 6. The tape and reel dimensions are provided in Figure 7.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The AWB7231 is rated to Moisture Sensitivity Level 4 (MSL4) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



Notes:

- 1. Unless specified, dimensions are symmetrical about center lines shown.
- 2. Dimensions are in millimeters.
- 3. Vias shown in PCB Metal View are for reference only. Number and size of thermal vias required are dependent on heat dissipation requirements and the PCB process capability.

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Figure 4. AWB7231 PCB Layout Footprint Dimensions

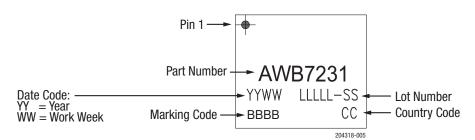
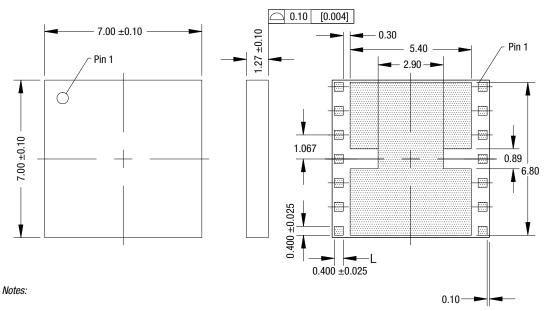


Figure 5. AWB7231 Typical Part Marking



- 1. All dimensions are in millimeters.
- 2. Unless specified otherwise, tolerance = ± 0.076 [0.003].
- Pads (including center) are shown as uniform size for reference only.
 Actual pad size and location will vary within the minimum and maximum dimensions according to the specific laminate design.

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Figure 6. AWB7231 Package Dimensions

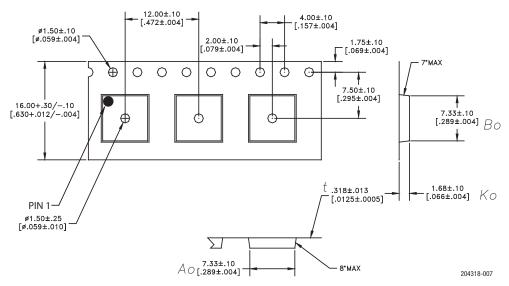


Figure 7. AWB7231 Tape and Reel Dimensions

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Ordering Information

Model Number	Package Description	Component Packaging		
AWB7231P8	RoHS-compliant 14-pin 7 x 7 x 1.3 mm surface-mount module	2500-piece tape and reel		
EVB7231		Evaluation Board part number		

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